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8-bit FET Bus Switch



ADE-205-644 (Z)

Preliminary Rev. 0 August 2001

### **Description**

The HD74CBT3345 provides eight bits of high speed TTL-compatible bus switching in a standard '245 device pinout. The low on state resistance of the switch allows connections to be made with minimal propagation delay. The device is organized as one 8-bit switch bank with dual output enable (OE and  $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low or OE is high, the switch is on, and port A is connected to port B. When  $\overline{OE}$  is high and OE is low, the switch is open, and the high impedance state exists between the two ports.

#### **Features**

- Standard '245 type pinout.
- Minimal propagation delay through the switch.
- 5  $\Omega$  switch connection between two ports.
- TTL-compatible input levels.
- Ultra low quiescent power.
  - -Ideally suited for notebook applications.

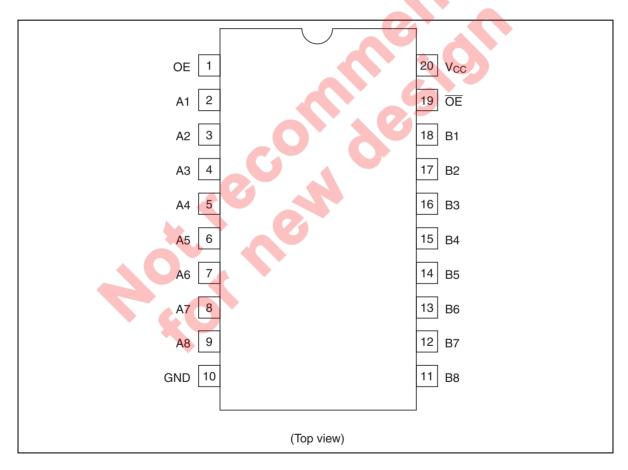
### **Function Table**

### Inputs

ŌĒ	OE	Function
L	X	A port = B port
X	Н	A port = B port
Н	L	Disconnect

H: High level
L: Low level
X: Immaterial

### **Pin Arrangement**



### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	-0.5 to 7.0	V	
Input voltage range 1	V,	-0.5 to 7.0	V	
Input clamp current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> < 0
Continuous output current	I <sub>o</sub>	128	mA	$V_{o} = 0 \text{ to } V_{cc}$
Continuous current through $V_{cc}$ or GND	I <sub>cc</sub> or I <sub>GND</sub>	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) <sup>'2</sup>	$P_{\scriptscriptstyle T}$	757	mW	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes:

The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

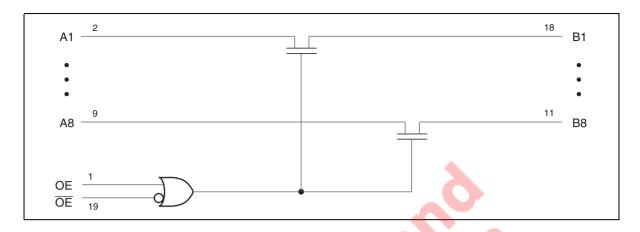
- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. The maximum package power dissipation was calculated using a junction temperature of 150°C.

### **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	4.5	<b>5</b> .5	V	_
Input voltage range	Vi	0	5.5	V	
Output voltage range	V <sub>I/O</sub>	0	5.5	V	_
Input transition rise or fall rate	Δt / Δν	0	5	ns / V	V <sub>cc</sub> = 4.5 to 5.5 V
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

### **Block Diagram**



#### **DC Electrical Characteristics**

 $(Ta = -40 \text{ to } 85^{\circ}C)$ 

Item	Symbol	$V_{cc}(V)$	Min	Typ <sup>™</sup>	Max	Unit	Test conditions
Clamp diode voltage	V <sub>IK</sub>	4.5	_	_	-1.2	V	$I_{IN} = -18 \text{ mA}$
Input voltage	V <sub>IH</sub>	4.5 to 5.5	2.0	_	_	V	
	V <sub>IL</sub>	4.5 to 5.5	_	_	0.8	<del></del>	
On-state switch resistance <sup>2</sup>	R <sub>on</sub>	4.5	_	5	7	Ω	$V_{IN} = 0 V,$ $I_{IN} = 64 \text{ mA}$
		4.5	_	5	7		$V_{IN} = 0 \text{ V},$ $I_{IN} = 30 \text{ mA}$
		4.5	_	10	15		$V_{IN} = 2.4 \text{ V},$ $I_{IN} = 15 \text{ mA}$
Input current	I <sub>IN</sub>	0 to 5.5	_	_	±1.0	μΑ	V <sub>IN</sub> = 5.5 V or GND
Off-state leakage current	l <sub>oz</sub>	5.5	_	-	±1.0	μА	0 ≤ A, B ≤ V <sub>cc</sub>
Quiescent supply current	I <sub>cc</sub>	5.5	_		3	μА	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0$ mA
Increase in I <sub>cc</sub> per input '3	$\Delta I_{cc}$	5.5	O O		2.5	mA	One input at 3.4 V, other inputs at $V_{\rm cc}$ or GND

Notes: For condition shown as Min or Max use the appropriate values under recommended operating conditions.

- 1. All typical values are at  $V_{cc}$  = 5 V (unless otherwise noted), Ta = 25°C.
- 2. Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower voltage of the two (A or B) terminals.
- 3. This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{cc}$  or GND.

### Capacitance

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	$V_{cc}$ (V)	Min	Тур	Max	Unit	Test conditions
Control input capacitance	C <sub>IN</sub>	5.0	_	3.5	_	pF	$V_{IN} = 0 \text{ or } 3 \text{ V}$
Input / output capacitance	C <sub>I/O (OFF)</sub>	5.0	_	5	_	pF	$\frac{V_o}{OE} = 0 \text{ or } 3 \text{ V}$

Note: This parameter is determined by device characterization is not production tested.

### **Switching Characteristics**

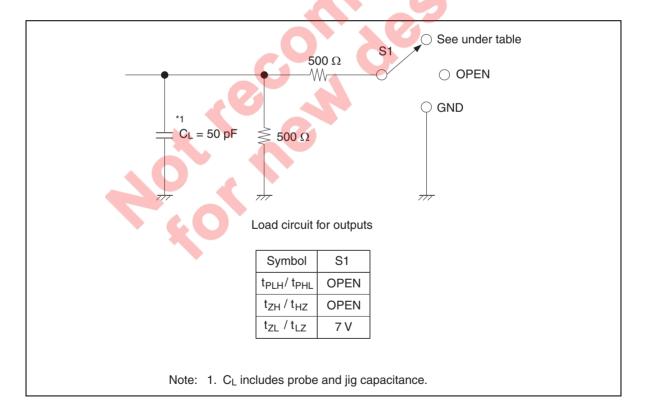
 $(Ta = -40 \text{ to } 85^{\circ}C)$ 

•  $V_{cc} = 5.0 \pm 0.5 \text{ V}$ 

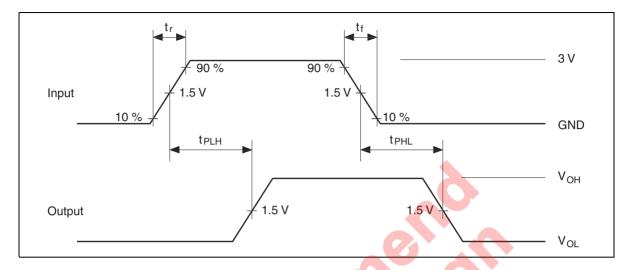
Item	Symbol	Min	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time 11	t <sub>plH</sub> t <sub>pHL</sub>	_	0.25	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	A or B	B or A
Enable time	t <sub>zh</sub> t <sub>zL</sub>	1.0	9.1	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	ŌĒ	A or B
Disable time	t <sub>HZ</sub> t <sub>LZ</sub>	1.0	8.7	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	ŌĒ	A or B

Note: 1. The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

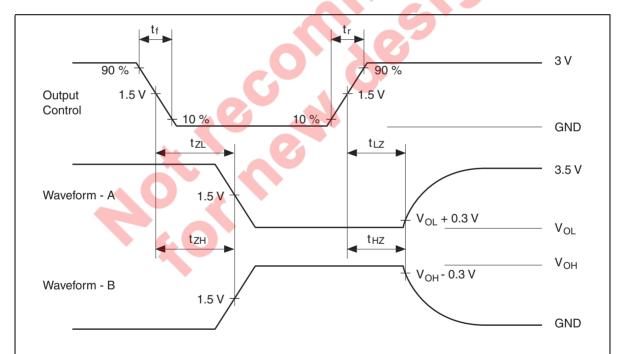
#### **Test Circuit**



#### Waveforms - 1



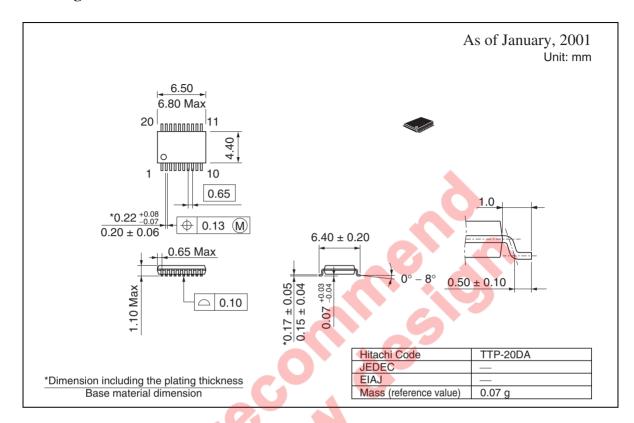
#### Waveforms - 2



Notes: 1. All input pulses are supplied by generators having the following characteristics : PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_r \leq$  2.5 ns,  $t_f \leq$  2.5 ns.

- 2. Waveform A is for an output with internal conditions such that the output is low except when disabled by the output control.
- 3. Waveform B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. The output are measured one at a time with one transition per measurement.

### **Package Dimensions**



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